



**DOCUMENT TITLE:**

**PACKAGE OUTLINE, 2 BUMPS FLIP CHIP, 1.32X0.66X0.54MM, 0.704MM PITCH**

**DOC ID # 21-0378**

**NEW REV: B**

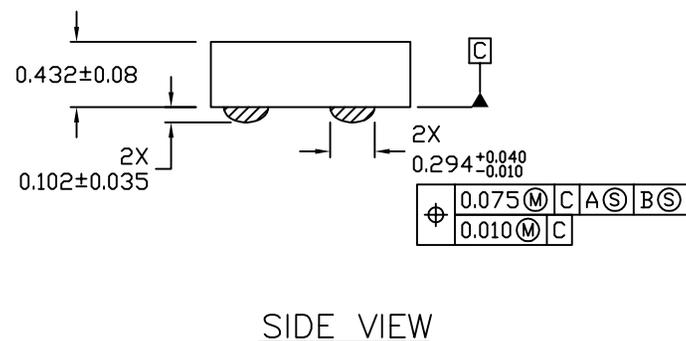
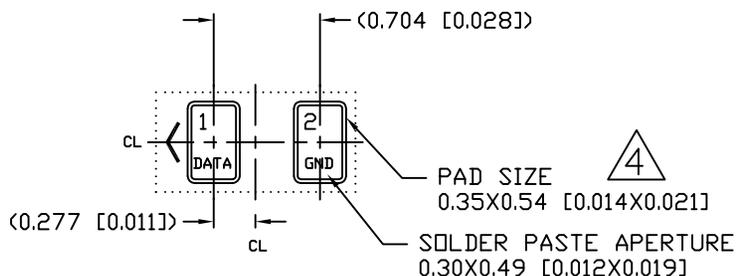
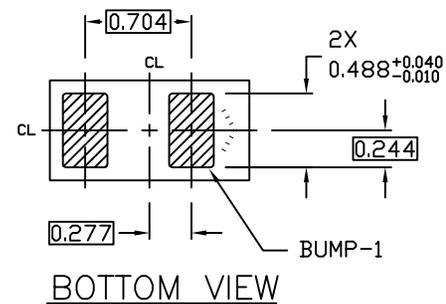
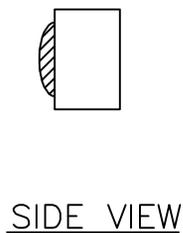
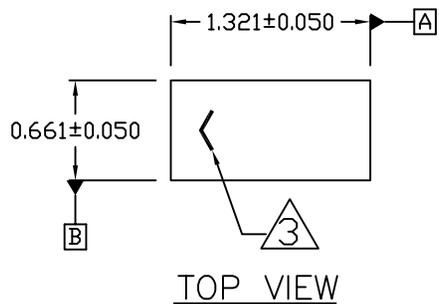
**ECN#: HQ-10-1934**

**EFFECTIVE DATE: 10-22-2010**

**ORIGINATOR: MOONLORD MANALO**

**MOST RECENT CHANGES**

<b>FROM</b>	<b>TO</b>
OLD BORDER/TEMPLATE; TITLE: DS2401X1 CHIP SCALE PACKAGE, PACKAGE CODE: BF211-1	NEW/UPDATED BORDER/TEMPLATE; TITLE: PACKAGE OUTLINE, 2 BUMPS FLIP CHIP, 1.32X0.66X0.54MM, 0.704MM PITCH



- NOTES:
1. DIMENSIONS ARE IN MILLIMETERS [INCHES].
  2. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
  3. LASER MARK
  4. LANDING PAD NOT DEFINED BY SOLDER MASK
  5. ALL DIMENSIONS APPLY TO LEADED (-) PKG. CODE ONLY.
  6. PACKAGE CODES: BF211-1

**MAXIM**

TITLE:  
PACKAGE OUTLINE, 2 BUMPS FLIP CHIP,  
1.32x0.66x0.54mm, 0.704mm PITCH

APPROVAL EDEN CHEN 10-20-10	DOCUMENT CONTROL NO. 21-0378	REV. B	1/1
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-DRAWING NOT TO SCALE-

**REVISION HISTORY**

REV	CHANGES MADE	DATE	INIT.
A	ECN# HQ-08-5741. INITIAL RELEASE INTO MAXIM DOCUMENT CONTROL. LOGO-MAXIM	07/15/08	JW
B	ECN# HQ-10-1934. CHANGED TO THE NEW BORDER/TEMPLATE. ADDED CORRESPONDING PACKAGE CODE.	10/22/10	MOONLORD MANALO



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**DOCUMENT I.D.**  
21-0378

**REVISION**  
B

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